

L Number	Hits	Search Text	DB	Time stamp
-	0	semiconductor and damascene and (copper or Cu) and seed and (tantalum or TaN) and (in adj situ) and (transfer adj chamber) and (mask or resist or photoresist or photomask) and (etch adj stop) and dielectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/29 16:01
-	1	semiconductor and damascene and (copper or Cu) and seed and (tantalum or TaN) and (transfer adj chamber) and (mask or resist or photoresist or photomask) and (etch adj stop) and dielectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/15 10:29
-	2	semiconductor and damascene and (copper or Cu) and seed and (tantalum or TaN) and (in adj situ) and (mask or resist or photoresist or photomask) and (etch adj stop) and dielectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/15 10:31
-	180	semiconductor and damascene and (copper or Cu) and seed and (tantalum or TaN) and (mask or resist or photoresist or photomask) and (etch adj stop) and dielectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/15 15:51
-	43	(semiconductor and damascene and (copper or Cu) and seed and (tantalum or TaN) and (mask or resist or photoresist or photomask) and (etch adj stop) and dielectric ) and (ash\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/15 15:51
-	4100	(438/687-696).CCLS.	USPAT; US-PGPUB	2002/10/15 14:32
-	13	((438/687-696).CCLS.) and ash\$3 and "in situ"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/15 14:34
-	180	semiconductor and damascene and (copper or Cu) and seed and (tantalum or TaN) and (mask or resist or photoresist or photomask) and (etch adj stop) and dielectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/17 09:53
-	1	semiconductor and damascene and (copper or Cu) and (mask or resist or photoresist or photomask) and (etch adj stop) and dielectric and impurit\$3 and "in situ"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/17 09:55
-	30	semiconductor and damascene and (copper or Cu) and dielectric and impurit\$3 and (in adj situ)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/17 10:00
-	112	semiconductor and (copper or Cu) and dielectric and impurit\$3 and (in adj situ)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/17 10:00
-	82	(semiconductor and (copper or Cu) and dielectric and impurit\$3 and (in adj situ) ) not (semiconductor and damascene and (copper or Cu) and dielectric and impurit\$3 and (in adj situ) )	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/17 10:00
-	39	semiconductor and (copper or Cu) and trench and (etch adj stop) and (insitu or (in adj situ))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/29 16:08
-	33	semiconductor and (copper or Cu) and trench and (etch adj stop) and (expos\$5 with atmosphere)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/29 16:17

-	107	semiconductor and (copper or Cu) and trench and (etch adj stop) and (impurities)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/29 16:19
-	82	semiconductor and (copper or Cu) and trench and (etch adj stop) and (vacuum and contamination\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/29 16:22
-	99	semiconductor and (multichamber with apparatus) and deposition	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/29 16:28
-	1	("6201999").PN.	USPAT	2002/10/29 16:25
-	27	semiconductor and (multichamber with apparatus) and (trench and (copper or Cu))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/29 16:57
-	3	((("4784973") or ("4920072") or ("4920073"))).PN.	USPAT	2002/10/29 16:53
-	1	("5102827").PN.	USPAT	2002/10/29 16:57
-	1	("6139697").PN.	USPAT	2002/10/29 16:57
-	32	("4784973"   "4920072"   "4920073"   "4926237"   "4938996"   "4951601"   "4960732"   "4985750"   "4994410"   "5010032"   "5023201"   "5028565"   "5043299"   "5043300"   "5081064"   "5091339"   "5102826"   "5102827"   "5106781"   "5143867"   "5147819"   "5250465"   "5250467"   "5292558"   "5354712"   "5380682"   "5439731"   "5478780"   "5480836"   "5514425"   "5585673"   "5607776").PN.	USPAT	2002/10/29 16:58
-	1	("6348407").PN.	USPAT	2002/10/30 10:02
-	8	("5733706"   "5830801"   "6040243"   "6054379"   "6218302"   "6232235"   "6251804"   "6271593").PN.	USPAT	2002/10/30 09:32
-	1	("5448732").PN.	USPAT	2002/10/30 10:02